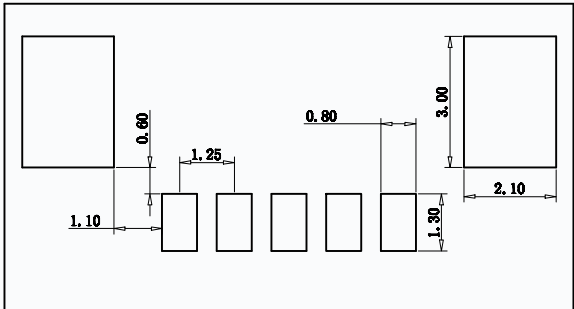
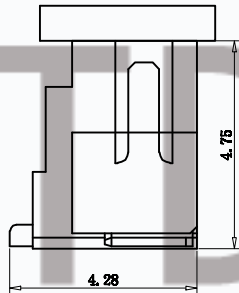
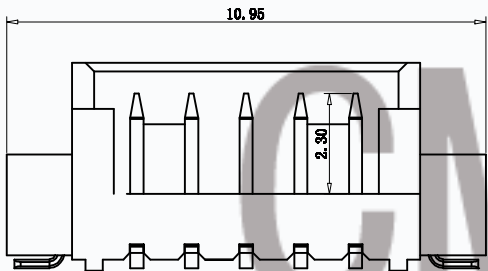
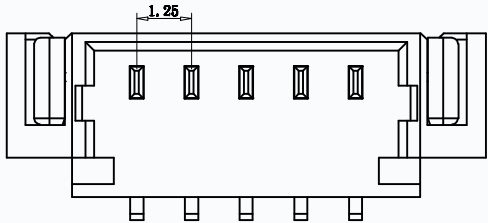


REV.	DESCRIPTION	APPD	DATE



- NOTES:
- 1. MATERIAL:
HOUSING: HIGH TEMPERATURE THERMOPLASTIC
UL94V_0
CONTACT: COPPER ALLOYS.
COVER: COPPER ALLOYS OR STEEL.
 - 2. PLATING:
UNDERPLATE: NICKEL.
 - 3. MULTIMEDIA CARD COMPATIBLE

PART NO:		MATERIAL:		CMTDDZ 东莞市田都科技有限公司 Dongguan TianDu Technology Co. Ltd.	
LOT NO:		FINSH:			
UNIT: MM	SIZE: A4	COLOR:		TITLE: 1.25间距 立贴	
TOLERANCES:		DR: ERIC			
GENERAL ANGLE:		CHK:		DWG NO: T19-125LL 系列	
X, X=±0.35				REV: A	
X, XX=±0.25					
X, XXX=±0.15		APP:		SCALE: 1:1	
X, XX=±2.0°				SHEET: 1 OF 1	
					